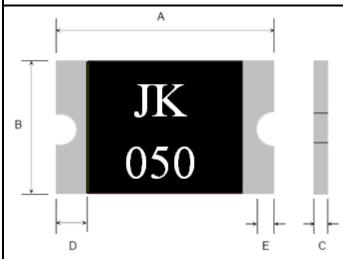
## JK-mSMD050 PPTC DEVICES

Part Number: Q/JKTD-15-050

#### Edition: AO

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Terminal pad materials :Tin-Plated Nickle-copper

Terminal pad solderability : Meets EIA specification RS 186-9E and ANSI/J-STD-002 Category 3.

Marking : JK050=1812(050)

Model	Marking	А		В		С		D	Е
		Min.	Max.	Min.	Max.	Min.	Max	Min.	Min
JK-mSMD050	JK <b>050</b>	4.37	4.73	3.07	3.41	0.40	0.90	0.30	0.25

#### Table2 :PERFORMANCE RATINGS:

Model	$V_{\text{max}}$	I <sub>max</sub>	Ihold	I <sub>trip</sub>	Pd	Maximum		Resistance		
			@25°C	@25°C	Тур	Time 7	To Trip			
						Current	Time	$Ri_{min}$	Ri <sub>typ</sub>	$R1_{max}$
	(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	$(\Omega)$	(Ω)	(Ω)
JK-mSMD050	15.0	100	0.50	1.00	0.8	8.0	0.15	0.150	0.250	1.000

## Table3:Test Conditons and Standards

Item	Test Conditon	Standard		
Initial Resistance	25°C	$0.150{\sim}1.000\Omega$		
I <sub>H</sub>	25°C, 0.50A, 60min	No Trip		
Ttrip	25°C, 8.0A	≤0.15s		
Trip endurance	15V, 100A, 1hr	No arcing or burning		

Operating Temperature: -40°C TO 85°C Packaging: Bulk ,2000 pcs per bag

Tackaging: Durk,2000 pcs per t

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IEL: 80-709-83237001

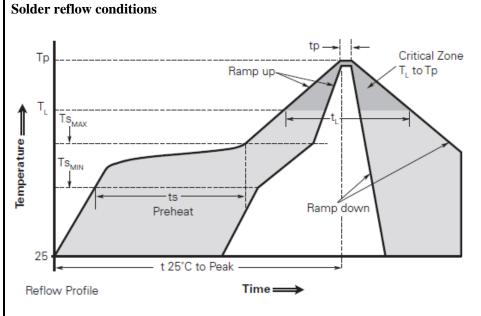
E-mail:sales-dg@zonkas.com.cn

# JK-mSMD050 PPTC DEVICES

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Profile Feature	Pb-Free Assembly
Average ramp up rate (Ts <sub>MAX</sub> to Tp)	3°C/second max.
Preheat	
<ul> <li>Temperature min. (Ts<sub>MIN</sub>)</li> </ul>	150°C
<ul> <li>Temperature max. (Ts<sub>MAX</sub>)</li> </ul>	200°C
<ul> <li>Time (ts<sub>MIN</sub> to ts<sub>MAX</sub>)</li> </ul>	60-120 seconds
Time maintained above:	
• Temperature (T <sub>L</sub> )	217°C
• Time (t <sub>L</sub> )	60-150 seconds
Peak/Classification temperature (Tp)	260°C
Time within 5°C of actual peak temperat	ure
Time (tp)	30 seconds max.
Ramp down rate	3°C/second max.
Time 25°C to peak temperature	8 minutes max.

- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25mm (0.010inch).
- Devices can be cleaned using standard industry methods and solvents.
- Soldering temprature profile meets RoHs leadfree process.

Note: All temperatures refer to topside of the package, measured on the package body surface.

Notes: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements

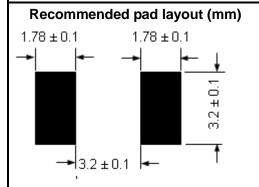
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# JK-mSMD050 PPTC DEVICES

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### WARNING

 $\cdot$  Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

 $\cdot$  PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.

 $\cdot$  Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

· Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.

· Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.

 $\cdot$  Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.PPTC SMD can be cleaned by standard methods.

 $\cdot$  Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profilecould negatively impact solderability performance of our devices.

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